Vishay Siliconix



HVMDIP

PRODUCT SUMMARY

V_{DS} (V)

R_{DS(on)} (Ω)

Q_{qs} (nC)

Q_{ad} (nC)

Qg (Max.) (nC)

Configuration

Power MOSFET

s

N-Channel MOSFET

0.27

100

16

4.4

7.7

Single

 $V_{GS} = 10 V$

FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- · For automatic insertion
- End stackable
- 175 °C operating temperature
- · Fast switching
- Ease of paralleling
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION	
Package	HVMDIP
Lead (Pb)-free	IRFD123PbF

ABSOLUTE MAXIMUM RATINGS (TA	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	100	v		
Gate-source voltage			V _{GS}	± 20	V	
Continuous drain current	V _{GS} at 10 V	T _A = 25 °C T _A = 100 °C	1-	1.3		
	V _{GS} at 10 V	T _A = 100 °C	I _D	0.94	А	
Pulsed drain current ^a			I _{DM}	10	1	
Linear derating factor				0.0083	W/°C	
Single pulse avalanche energy ^b			E _{AS}	100	mJ	
Repetitive avalanche current ^a			I _{AR}	1.3	А	
Repetitive avalanche energy ^a			E _{AR}	0.13	mJ	
Maximum power dissipation T _A = 25 °C		PD	1.3	W		
Peak diode recovery dV/dt ^c			dV/dt	5.5	V/ns	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	O		
Soldering recommendations (peak temperature)	For	10 s	300 ^d			

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 22 mH, R_g = 25 Ω , I_{AS} = 2.6 A (see fig. 12)
- c. $I_{SD} \le 9.2$ A, dI/dt ≤ 110 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C
- d. 1.6 mm from case

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	120	°C/W

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		- -					
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	= 0 V, I _D = 250 μA	100	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Referen	ce to 25 °C, $I_D = 1 \text{ mA}$	-	0.13	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS}	= V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
	I _{DSS}	V _{DS}	V _{DS} = 100 V, V _{GS} = 0 V		-	25	
Zero Gate Voltage Drain Current		V _{DS} = 80 V	∕, V _{GS} = 0 V, T _J = 150 °C	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 0.78 A ^b	-	-	0.27	Ω
Forward Transconductance	g _{fs}	V _{DS} =	= 50 V, I _D = 0.78 A ^b	0.80	-	-	S
Dynamic		-					I
Input Capacitance	C _{iss}	V _{GS} = 0 V		-	360	-	pF
Output Capacitance	C _{oss}		$V_{DS} = 25 V$		150	-	
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		-	34	-	
Total Gate Charge	Qg			-	-	16	
Gate-Source Charge	Q_gs	V _{GS} = 10 V	I _D = 9.2 A, V _{DS} = 80 V see fig. 6 and 13 ^b	-	-	4.4	nC
Gate-Drain Charge	Q _{gd}			-	-	7.7	
Turn-On Delay Time	t _{d(on)}			-	6.8	-	
Rise Time	t _r	Vaa	= 50 V, I _D = 9.2 A	-	27	-	
Turn-Off Delay Time	t _{d(off)}		$V_{DD} = 50 V, I_D = 9.2 A$ $R_g = 18 \Omega, R_D = 5.2 \Omega, see fig. 10^{b}$		18	-	ns
Fall Time	t _f			-	17	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-	
Internal Source Inductance	L _S			-	6.0	-	nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the		-	-	1.3	A
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction		-	-	10	
Body Diode Voltage	V _{SD}	T _J = 25 °C	, $I_{\rm S}$ = 1.3 A, $V_{\rm GS}$ = 0 V ^b	-	-	2.5	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 %0 1		-	130	260	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$I_{\rm J} = 25 ^{\circ}{\rm C}, I_{\rm F}$	= 9.2 A, dl/dt = 100 A/µs ^b	-	0.65	1.3	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

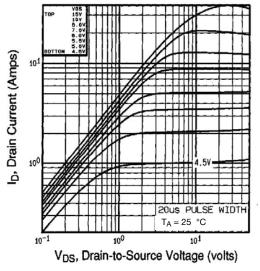


Fig. 1 - Typical Output Characteristics, $T_A = 25 \ ^\circ C$

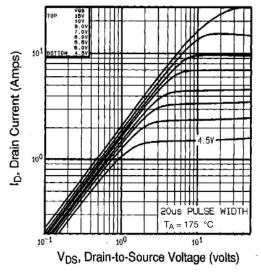
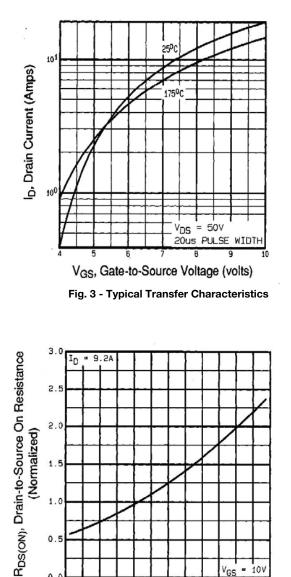


Fig. 2 - Typical Output Characteristics, T_A = 175 $^\circ C$



0.060 - 40 - 20 0 20 40 50 80 100 120 140 150 180T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature



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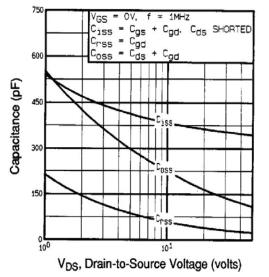


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

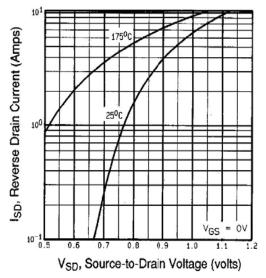


Fig. 7 - Typical Source-Drain Diode Forward Voltage

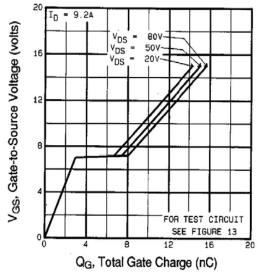
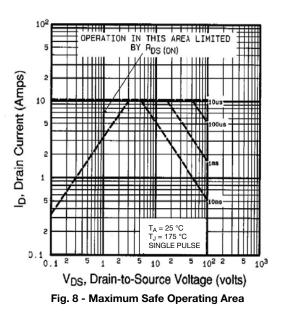


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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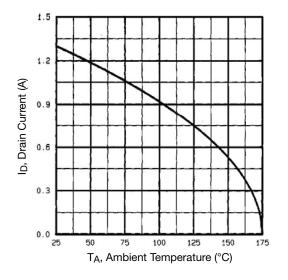


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

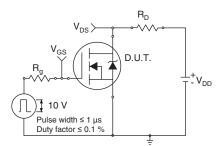


Fig. 10a - Switching Time Test Circuit

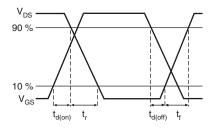


Fig. 10b - Switching Time Waveforms

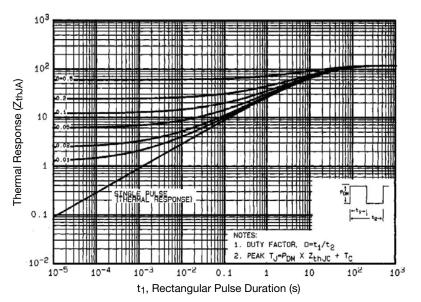


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



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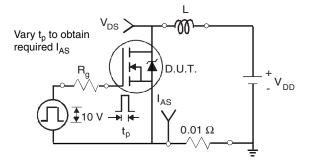


Fig. 12a - Unclamped Inductive Test Circuit

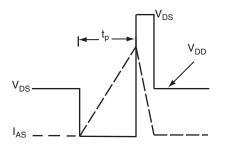


Fig. 12b - Unclamped Inductive Waveforms

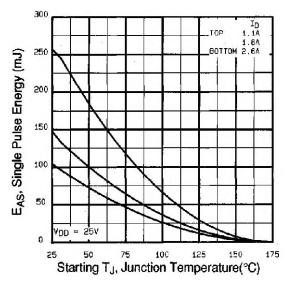
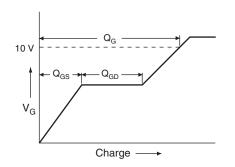


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





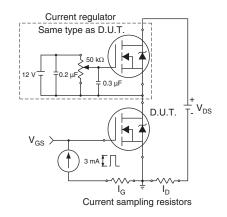


Fig. 13b - Gate Charge Test Circuit

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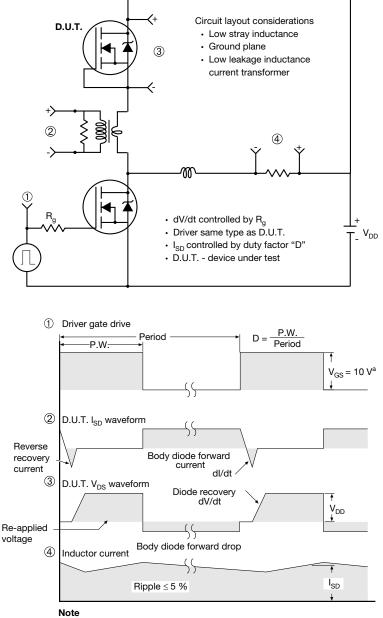
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Peak Diode Recovery dV/dt Test Circuit



a. V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel

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HVM DIP (High voltage)





	INCHES		MILLIN	IETERS
DIM.	MIN.	MAX.	MIN.	MAX.
А	0.310	0.330	7.87	8.38
E	0.300	0.425	7.62	10.79
L	0.270	0.290	6.86	7.36
ECN: X10-0386-Rev. B, 0 DWG: 5974	06-Sep-10			

Note

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.



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